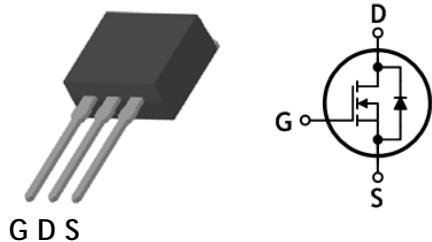


## HIGH SPEED SWITCHING APPLICATION

### Features

- Low drain-source On resistance:  $R_{DS(on)}=2.3\Omega$  (Typ.)
- Low gate charge:  $Q_g=10nC$  (Typ.)
- Low reverse transfer capacitance:  $C_{rss}=4.7pF$  (Typ.)
- RoHS compliant device
- 100% avalanche tested

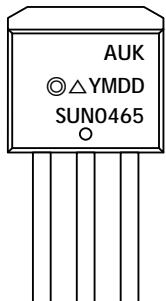


### Ordering Information

| Part Number | Marking | Package |
|-------------|---------|---------|
| SUN0465I2   | SUN0465 | TO-PAK  |

TO-PAK

### Marking Information



Column 1: Manufacturer

Column 2: Production Information

e.g.) ©△YMDD

- . ©: Option Code (H: Halogen Free)

- . △: Factory Management Code

- . YMDD: Date Code (Year, Month, Date)

Column 3: Device Code

### Absolute maximum ratings ( $T_c=25^\circ C$ unless otherwise noted)

| Characteristic                                   | Symbol    | Rating            | Unit       |
|--|-----------|-------------------|------------|
| Drain-source voltage                             | $V_{DSS}$ | 650               | V          |
| Gate-source voltage                              | $V_{GSS}$ | $\pm 30$          | V          |
| Drain current (DC) *                             | $I_D$     | $T_c=25^\circ C$  | A          |
|  |           | $T_c=100^\circ C$ | A          |
| Drain current (Pulsed) *                         | $I_{DM}$  | 16                | A          |
| Single avalanche energy <sup>(Note 2)</sup>      | $E_{AS}$  | 86.7              | mJ         |
| Repetitive avalanche current <sup>(Note 1)</sup> | $I_{AR}$  | 4                 | A          |
| Repetitive avalanche energy <sup>(Note 1)</sup>  | $E_{AR}$  | 11                | mJ         |
| Power dissipation                                | $P_D$     | 110               | W          |
| Junction temperature                             | $T_J$     | 150               | $^\circ C$ |
| Storage temperature range                        | $T_{stg}$ | -55~150           | $^\circ C$ |

\* Limited only maximum junction temperature

## Thermal Characteristics

| Characteristic                          | Symbol        | Rating    | Unit                        |
|---|---------------|-----------|-----------------------------|
| Thermal resistance, junction to case    | $R_{th(j-c)}$ | Max. 1.13 | $^{\circ}\text{C}/\text{W}$ |
| Thermal resistance, junction to ambient | $R_{th(j-a)}$ | Max. 50   |                             |

Electrical Characteristics ( $T_c=25^{\circ}\text{C}$  unless otherwise noted)

| Characteristic                                   | Symbol                   | Test Condition   | Min. | Typ. | Max.      | Unit          |
|--|--------------------------|--|------|------|-----------|---------------|
| Drain-source breakdown voltage                   | $\text{BV}_{\text{DSS}}$ | $I_D=250\mu\text{A}, V_{GS}=0$                         | 650  | -    | -         | V             |
| Gate threshold voltage                           | $V_{GS(\text{th})}$      | $I_D=250\mu\text{A}, V_{DS}=V_{GS}$                    | 3    | -    | 5         | V             |
| Drain-source cut-off current                     | $I_{\text{DSS}}$         | $V_{DS}=650\text{V}, V_{GS}=0\text{V}$                 | -    | -    | 1         | $\mu\text{A}$ |
|  |                          | $V_{DS}=650\text{V}, T_c=150^{\circ}\text{C}$          | -    | -    | 100       | $\mu\text{A}$ |
| Gate leakage current                             | $I_{GSS}$                | $V_{DS}=0\text{V}, V_{GS}=\pm 30\text{V}$              | -    | -    | $\pm 100$ | nA            |
| Drain-source on-resistance                       | $R_{DS(\text{ON})}$      | $V_{GS}=10\text{V}, I_D=2\text{A}$                     | -    | 2.3  | 3         | $\Omega$      |
| Forward transfer conductance <sup>(Note 3)</sup> | $g_{fs}$                 | $V_{DS}=10\text{V}, I_D=2\text{A}$                     | -    | 4.4  | -         | S             |
| Input capacitance                                | $C_{iss}$                | $V_{DS}=25\text{V}, V_{GS}=0\text{V}, f=1.0\text{MHz}$ | -    | 721  | -         | pF            |
| Output capacitance                               | $C_{oss}$                |  | -    | 54   | -         |               |
| Reverse transfer capacitance                     | $C_{rss}$                |  | -    | 4.7  | -         |               |
| Turn-on delay time <sup>(Note 3,4)</sup>         | $t_{d(on)}$              | $V_{DS}=325\text{V}, I_D=4\text{A}, R_G=25\Omega$      | -    | 42   | -         | ns            |
| Rise time <sup>(Note 3,4)</sup>                  | $t_r$                    |  | -    | 28   | -         |               |
| Turn-off delay time <sup>(Note 3,4)</sup>        | $t_{d(off)}$             |  | -    | 69   | -         |               |
| Fall time <sup>(Note 3,4)</sup>                  | $t_f$                    |  | -    | 22   | -         |               |
| Total gate charge <sup>(Note 3,4)</sup>          | $Q_g$                    | $V_{DS}=520\text{V}, V_{GS}=10\text{V}, I_D=4\text{A}$ | -    | 10   | 14        | nC            |
| Gate-source charge <sup>(Note 3,4)</sup>         | $Q_{gs}$                 |  | -    | 5    | -         |               |
| Gate-drain charge <sup>(Note 3,4)</sup>          | $Q_{gd}$                 |  | -    | 1.5  | -         |               |

Source-Drain Diode Ratings and Characteristics ( $T_c=25^{\circ}\text{C}$  unless otherwise noted)

| Characteristic                                | Symbol   | Test Condition  | Min. | Typ. | Max. | Unit          |
|---|----------|---|------|------|------|---------------|
| Source current (DC)                           | $I_s$    | Integral reverse diode in the MOSFET                                      | -    | -    | 4    | A             |
| Source current (Pulsed)                       | $I_{SM}$ |   | -    | -    | 16   | A             |
| Forward voltage                               | $V_{SD}$ | $V_{GS}=0\text{V}, I_{SD}=4\text{A}$                                      | -    | -    | 1.4  | V             |
| Reverse recovery time <sup>(Note 3,4)</sup>   | $t_{rr}$ | $I_{SD}=4\text{A}, V_{GS}=0\text{V}$<br>$dI_F/dt=100\text{A}/\mu\text{s}$ | -    | 498  | -    | ns            |
| Reverse recovery charge <sup>(Note 3,4)</sup> | $Q_{rr}$ |   | -    | 0.98 | -    | $\mu\text{C}$ |

Note:

1. Repeated rating: Pulse width limited by safe operating area
2.  $L=10\text{mH}, I_{AS}=4\text{A}, V_{DD}=50\text{V}, R_G=25\Omega$ , Starting  $T_j=25^{\circ}\text{C}$
3. Pulse test: Pulse width  $\leq 300\text{us}$ , Duty cycle  $\leq 2\%$
4. Essentially independent of operating temperature typical characteristics

## Typical Electrical Characteristics Curves

Fig. 1 Typical Output Characteristics

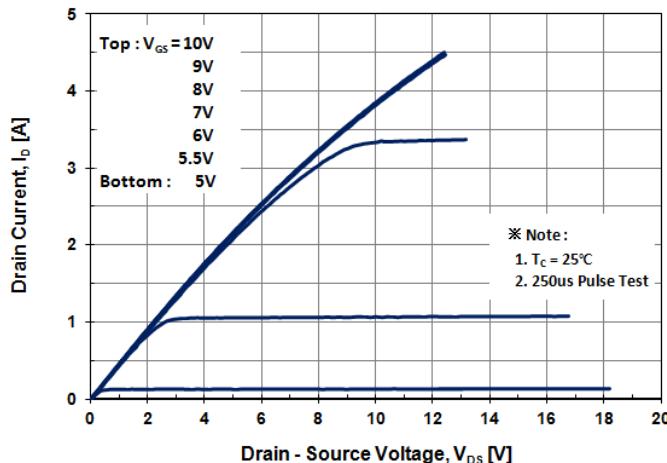


Fig.3 On-Resistance Variation with Drain Current and Gate Voltage

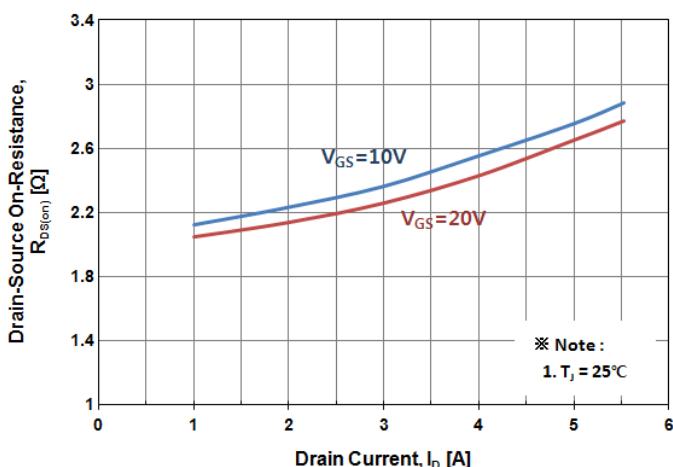


Fig. 5 Typical Capacitance Characteristics

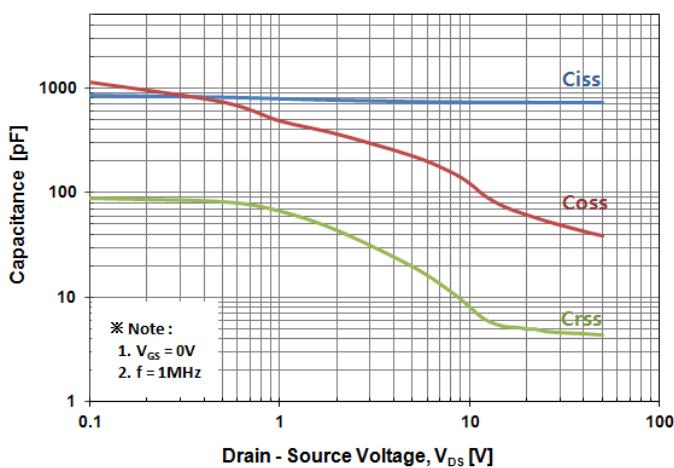


Fig. 2 Typical Output Characteristics

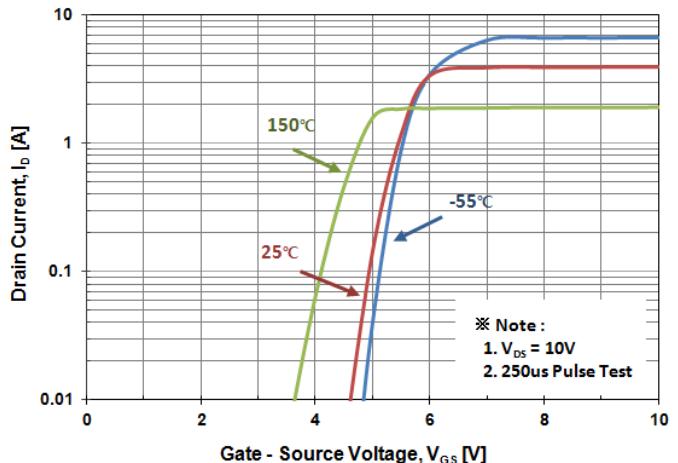


Fig. 4 Body Diode Forward Voltage Variation with Source Current

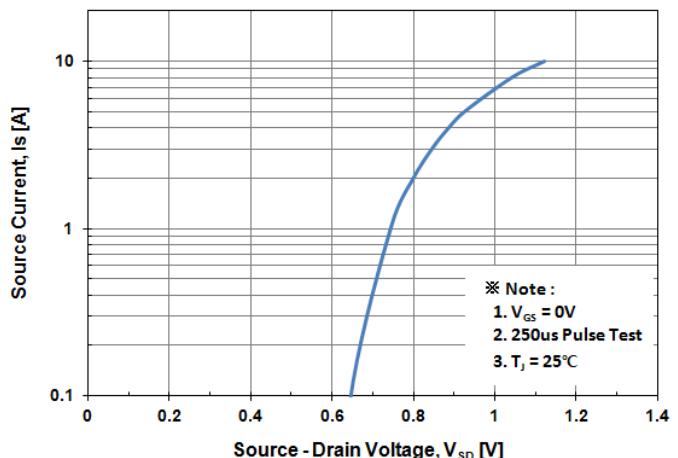


Fig. 6 Typical Total Gate Charge Characteristics

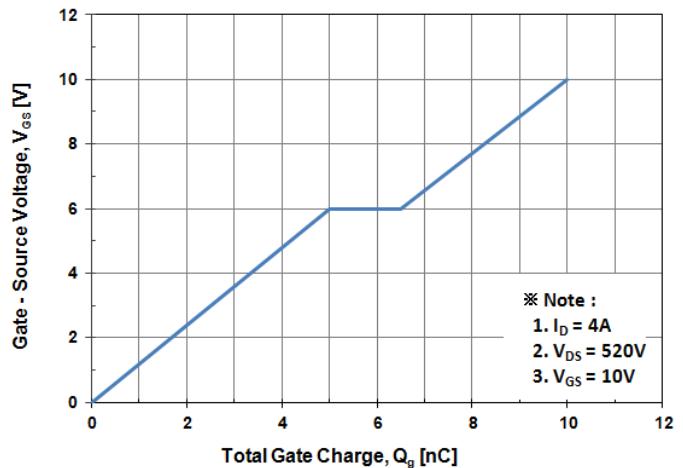


Fig. 7 Breakdown Voltage Variation vs. Temperature

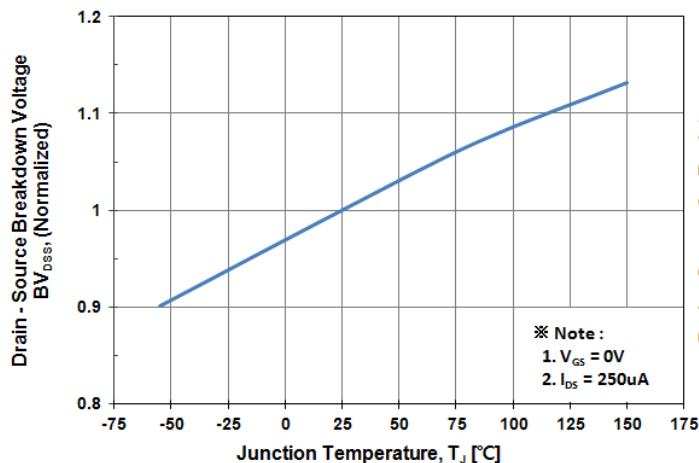


Fig. 8 On-Resistance Variation vs. Temperature

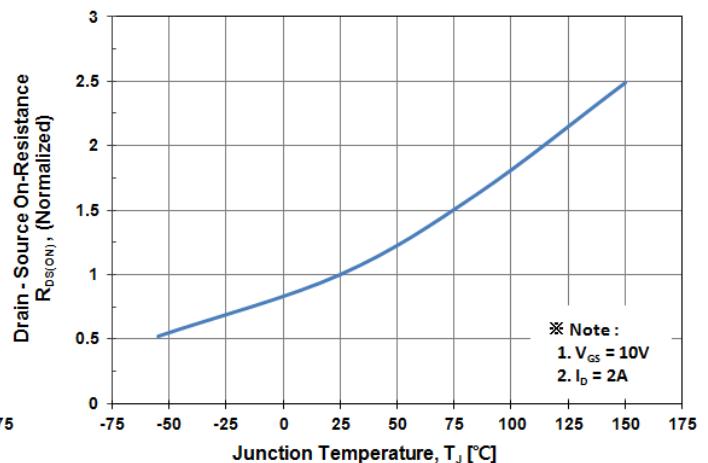


Fig. 9 Maximum Drain Current vs. Case Temperature

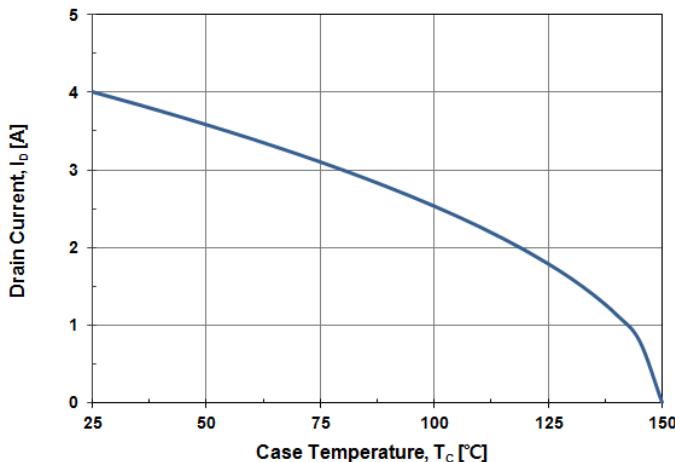


Fig. 10 Maximum Safe Operating Area

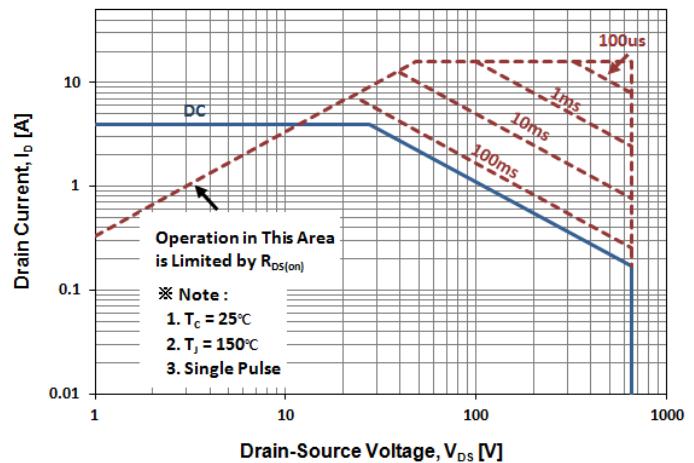


Fig. 11 Transient Thermal Impedance

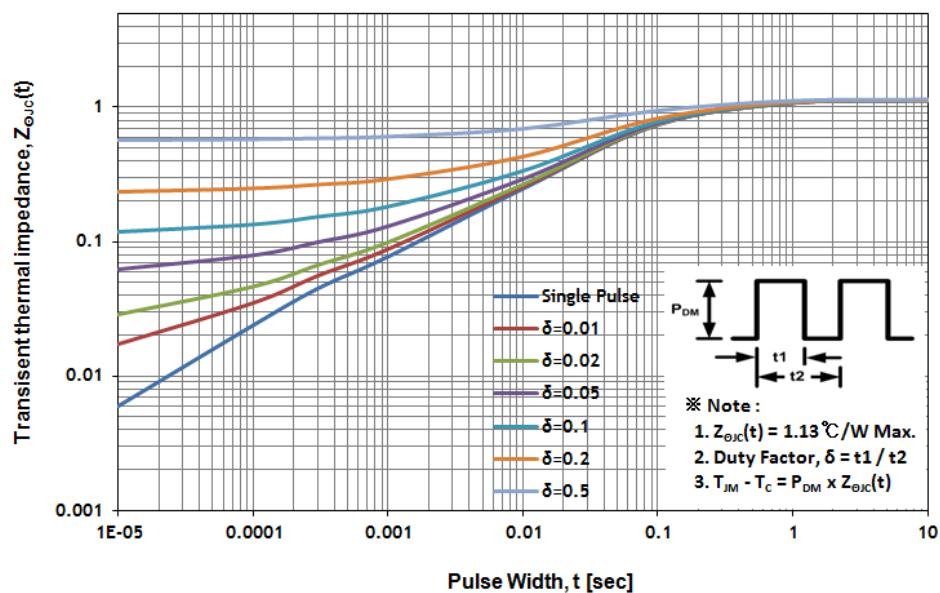


Fig. 12 Gate Charge Test Circuit & Waveform

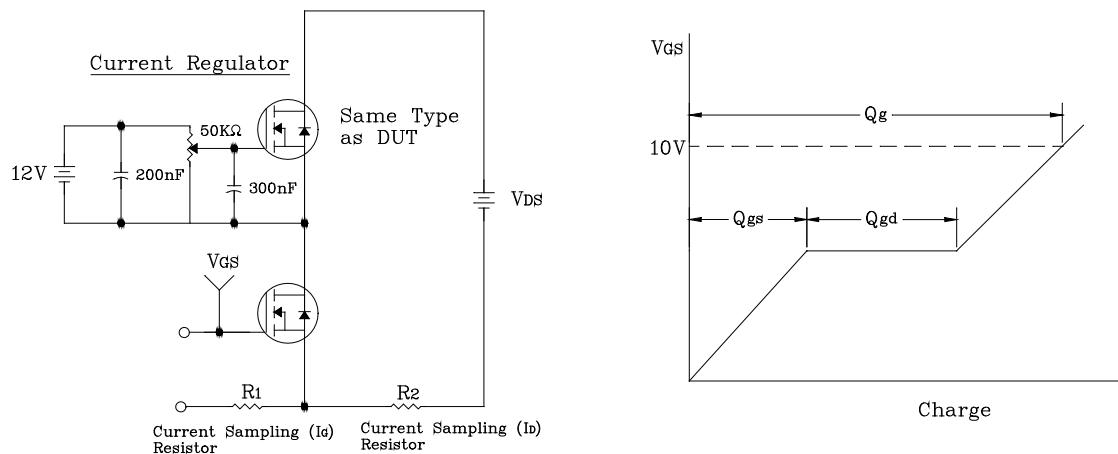


Fig. 13 Resistive Switching Test Circuit & Waveform

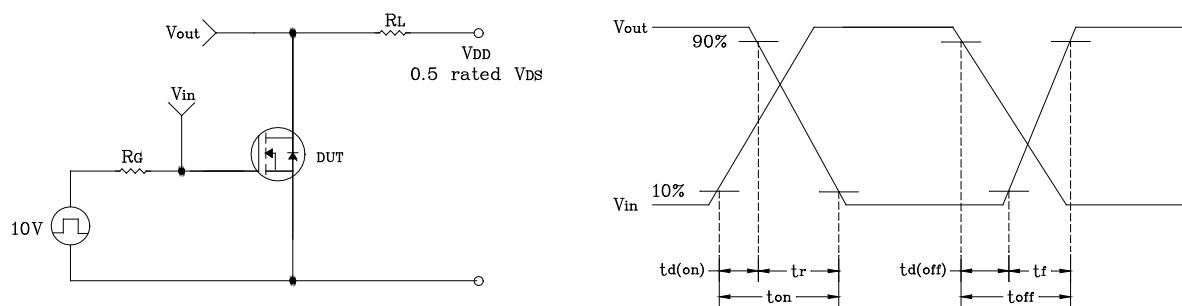


Fig. 14 E<sub>AS</sub> Test Circuit & Waveform

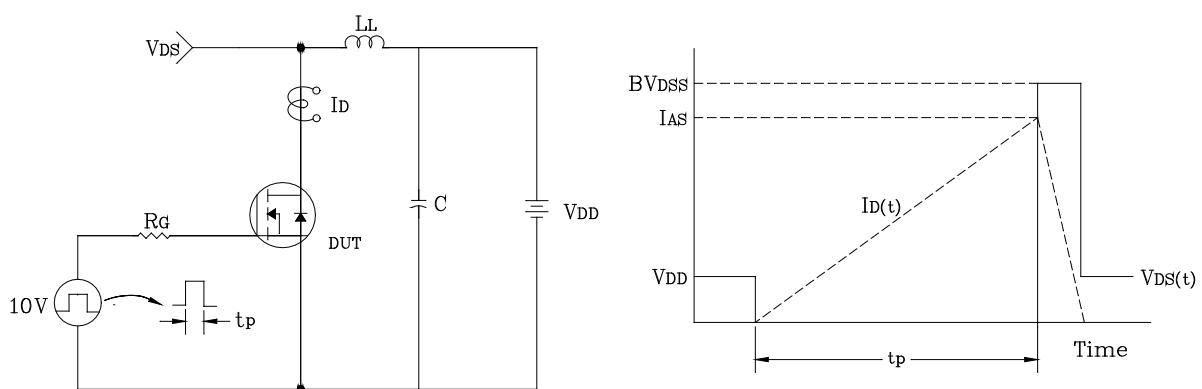
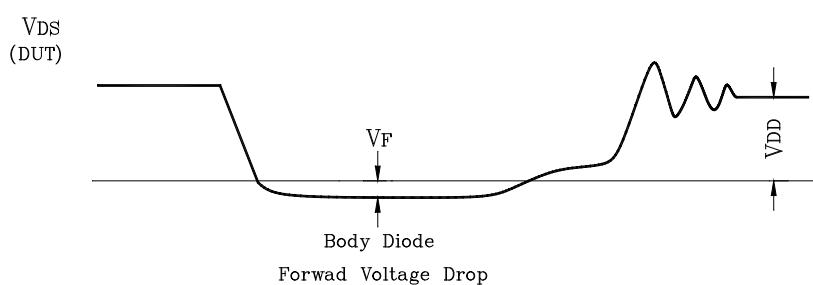
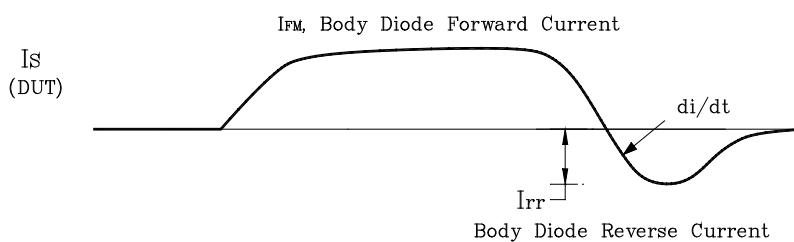
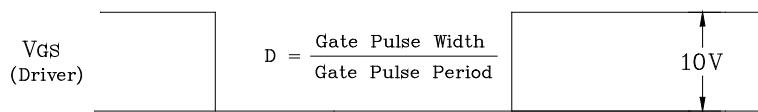
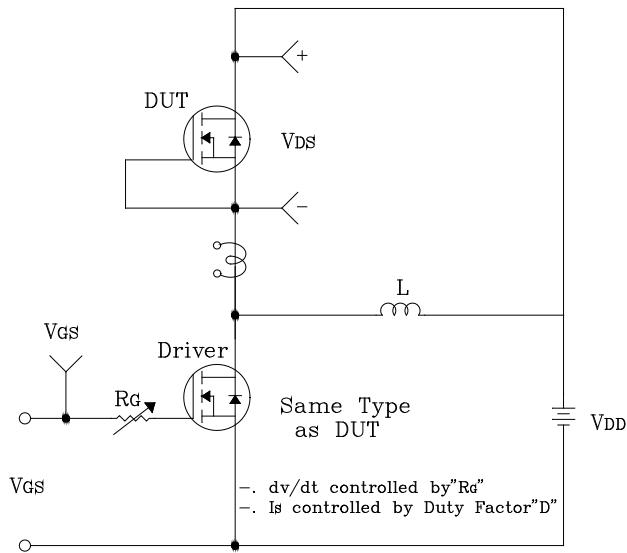
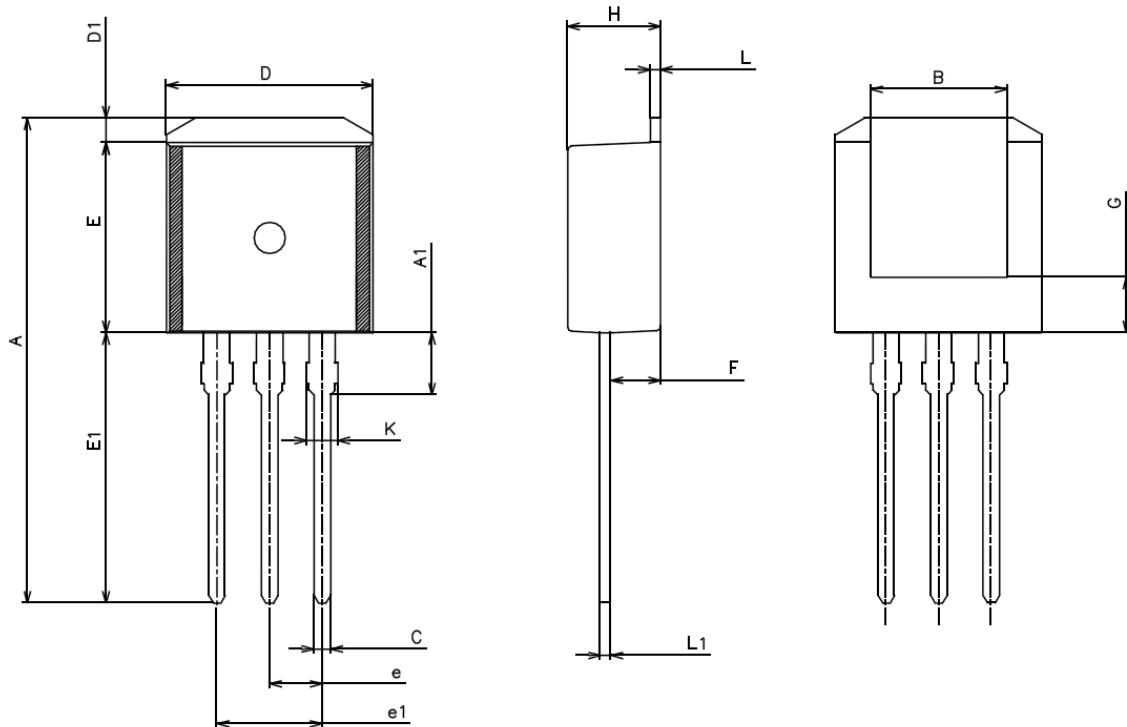


Fig. 15 Diode Reverse Recovery Time Test Circuit & Waveform



## Package Outline Dimensions



| SYMBOL | MILLIMETERS |         |         | NOTE |
|--------|-------------|---------|---------|------|
|        | MINIMUM     | NOMINAL | MAXIMUM |      |
| A      | 22.98       | 23.48   | 23.98   |      |
| A1     | 2.80        | 3.00    | 3.20    |      |
| B      | 6.40        | 6.60    | 6.80    |      |
| C      | 0.60        | 0.80    | 1.00    |      |
| D      | 9.80        | 10.00   | 10.20   |      |
| D1     | 1.00        | 1.20    | 1.40    |      |
| E      | 9.05        | 9.20    | 9.35    |      |
| E1     | 12.68       | 13.08   | 13.48   |      |
| e      | 2.34        | 2.54    | 2.74    |      |
| e1     | 4.88        | 5.08    | 5.28    |      |
| F      | 2.20        | 2.40    | 2.60    |      |
| G      | 2.50        | 2.70    | 2.90    |      |
| H      | 4.35        | 4.50    | 4.65    |      |
| K      | 1.42        | 1.52    | 1.62    |      |
| L      | 0.40        | 0.50    | 0.60    |      |
| L1     | 0.40        | 0.50    | 0.60    |      |

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